

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Farnworth et al.

Serial No.: 10/690,417

Filed: October 20, 2003

For: METHODS OF COATING AND
SINGULATING WAFERS (as amended)

Confirmation No.: 3773

Examiner: P. Perkins

Group Art Unit: 2822

Attorney Docket No.: 2269-5947US
(03-0316.00/US)



CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

October 10, 2005
Date


Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Examiner:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed August 4, 2005, the three-month shortened statutory period for response to which expires on November 4, 2005.

Amendments to the Title are reflected on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 14 of this paper.

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Serial No. 10/690,417

IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

METHODS OF COATING AND SINGULATING WAFERS ~~AND CHIP SCALE PACKAGES~~
~~FORMED THEREFROM~~